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1 &KDQQHO (QKDQFHPHQW ORGH)LHOG (

3URGXFW 6XPPDU\

" 9₆ 9

" ' \$

" 5₆ 2₁ DW 9 9 Ø P

" (\$6 7HVWHG

" j 9₆ 7HVWHG

*HQHUDO 'HVFULSWLRQ

" 6SOLW JDWH WUHQFK 026)(7 WHFKQRORJ

" ([FHOHQW SDXNDWHGLR VLSDWLRQ

" +LJK GHQVLW\ FHOQ GHVLJQ IRU ORZ 5

" 0RLVWXUH 6HQVLWLYLW\ /HYHO

" (SR[\ 0HHWV 8)ODPDELOLW\ 5DWLQJ

" +DORJHQ)UHH

" 3DUW QR ZLWKHQXIVL\$(& 4 TXDOLILHG

\$SSOLFDWLRQV

" 3RZHU VZLWFKLQJ DSSOLFDWLRQ

" 8QLQWHUUXSWLEOH SRZHU VXSSO\

" '& '& FRQYHUWU

v \$EVROXWH 0D[LPXFW 5DWLQJ MVV RWKHUZLVH QRWHG

3DUDPHWHU	6\PERO	/LPLW	8QLW
'UDLQ VRXUFH 9ROWDJH	9 ₆		9
*DWH VRXUFH 9ROWDJH	.6	9	9

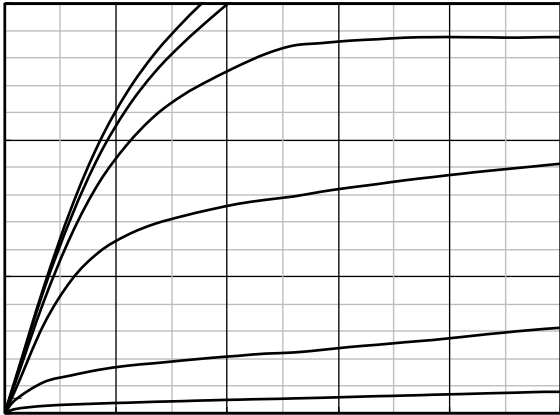
%	(\$6	P-
7 _{\$} -		
7 _{\$} -		
7 _{\$} -	3	:
7 _{&} -		



v (OHFWULFDO & KDUDFWXUDNWLFRWKHUZLVH QRWHG

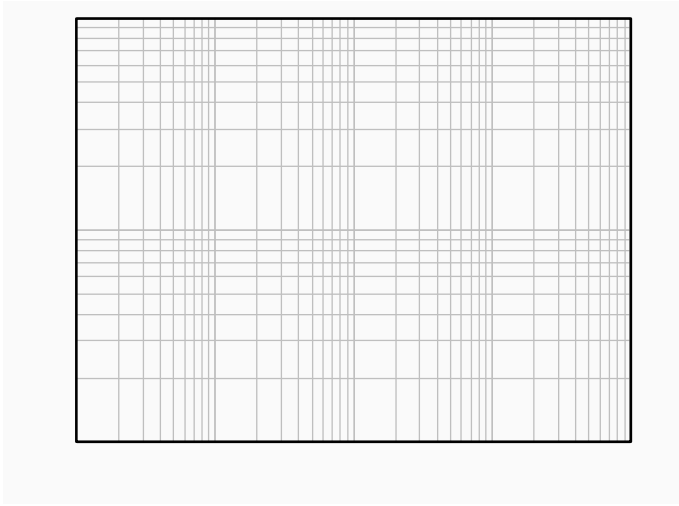
3DUDPHWHU	6\PERC	&RQGLWLRQV	0LQ	7\S	0D[8QLWV
6WDWLF 3DUDPHWHU						
'UDLQ 6RXUFH %UHDNGRZQ 9ROWDJH	6	%9, \$	9			9
=HUR *DWH 9ROWDJH 'UDLQ &XUHQW	6	9 ,9 9	9			\$
*DWH %RG\ /HDNDJH &XUHQW	6	6, " 9 ,9 9	9		"	Q\$

v7\SLFDO (OHFWULFDO DQG 7KHUPDO &KDUDFWHULVWLFV 'LDJUDP



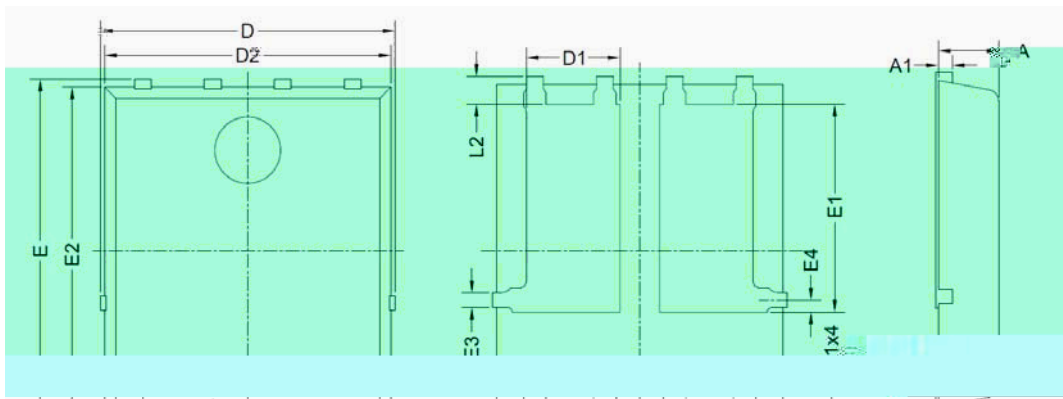


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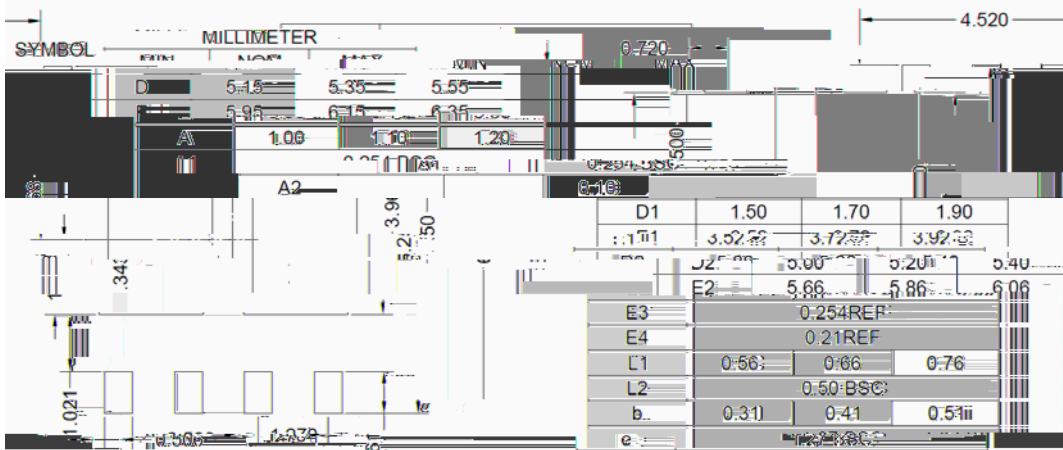
v 3')1 / 3DFNDJH LQIRUPDWLRQ



Bottom View
背面视图

Side View
侧面视图

Top View
正面视图



Note:

in millimeters.

Suggested Solder Pad Layout.

1. Controlling dimension:

3. The pad layout is for reference purposes only.

< - * ' * + + 4

6 '
5HY

6HS

<DQJJKRX <DQJMEH7H0K6WORDL&R /ZZZ \DQJMLH F